



SEMICON China 2026 Exhibition Announcement

Takatori Corporation will exhibit at **SEMICON China 2026**, to be held from March 25 to 27, 2026. We sincerely look forward to welcoming you to our exhibition locations.

Exhibition Highlights

New Model: Panel Level Packaging Machine PLP-700

Takatori will present its latest Panel Level Packaging machine, the **PLP-700**, designed to support panel sizes up to **700 mm × 700 mm**, through panel display.

We will introduce advanced semiconductor manufacturing solutions centered on this latest PLP platform.

For detailed information about the PLP-700, please visit us at SEMICON China 2026.

Exhibition Locations:

- Dong Rong Electronics Co.,Ltd. Booth No. N5-104
- Toyo Adtec Pte. Ltd. Booth No. N2-2760
- Kromax International Corp. Booth No. N1-1008
- TOTTECH SHANGHAI Co. Ltd. Booth No. N1-1242

New Model: Multi Wire Saw for 12-inch SiC MWS-SiC12F

Takatori will also present its latest multi-wire saw, the **MWS-SiC12F**, designed for slicing large-diameter ingots up to 12 inches in diameter (maximum supported diameter: 14 inches), through panel displays.

For detailed information about the MWS-SiC12F, please visit us at SEMICON China 2026.

Exhibition Location:

- Dong Rong Electronics Co.,Ltd. Booth No. N5-104

(SEMICON China2026 Official Website)

<https://www.semiconchina.org/>

